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Part Number: 0739425000

Status: Active

Overview: HDM Backplane Connector System

Description: HDM Board-to-Board Backplane Header, Vertical, Solder Tail, Open End, 144 Circuits

Documents:

3D Model Packaging Specification PK-70873-0818 (PDF)

Drawing (PDF) RoHS Certificate of Compliance (PDF)

Agency Certification

CSA LR19980 UL E29179

General

Product Family Backplane Connectors

Series 73942
Application Backplane
Comments Solder Tail
Component Type PCB Header

Overview HDM Backplane Connector System

Product Name HDM

UPC 800753935020

Physical

Circuits (Loaded) 144
Circuits (maximum) 144

Color - Resin Black, Natural

Durability (mating cycles max)

First Mate / Last Break

Flammability

Guide to Mating Part

Keying to Mating Part

None

Material - Metal Phosphor Bronze

Material - Plating Mating Gold Material - Plating Termination Tin

Material - Resin High Temperature Thermoplastic

Yes

Net Weight 6.273/g Number of Columns 24

Number of Pairs Open Pin Field

Number of Rows Orientation Vertical PC Tail Length 3.00mm **PCB** Locator Nο **PCB** Retention None PCB Thickness - Recommended 2.50mm Packaging Type Tube Pitch - Mating Interface 2.00mm Pitch - Termination Interface 2.00mm Plating min - Mating 0.762µm Plating min - Termination 2.540µm

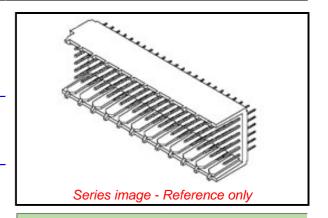
Temperature Range - Operating -55° to +105°C
Termination Interface: Style Through Hole

Electrical

Stackable

Surface Mount Compatible (SMC)

Current - Maximum per Contact 1.0A



EU ELV

Not Relevant

EU RoHS China RoHS

Compliant REACH SVHC Not Contained Per -ED/61/2018 (27 June

2018)
Halogen-Free
Status
Low-Halogen

Need more information on product environmental compliance?

Email <u>productcompliance@molex.com</u>
Please visit the <u>Contact Us</u> section for any non-product compliance questions.

China ROHS Green Image
ELV Not Relevant
RoHS Phthalates Not Contained

Search Parts in this Series

73942 Series

Mates With

73632 HDM+ Board-to-Board Daughtercard Receptacle. 73780 HDM Board-to-Board

Daughtercard Receptacle

Data Rate 1.0 Gbps Voltage - Maximum 250V AC

Solder Process Data

Duration at Max. Process Temperature (seconds) 040

Lead-freeProcess Capability SMC&WAVE

Max. Cycles at Max. Process Temperature 003
Process Temperature max. C 260

Material Info

Reference - Drawing Numbers

Packaging Specification PK-70873-0818
Sales Drawing SD-73942-001

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